

N-channel 40 V, 2.5 mΩ standard level MOSFET in LFPAK56 10 January 2025 Product data sheet

1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a robust LFPAK56 package. This product has been fully designed and qualified to meet AEC-Q101 requirements delivering high performance and endurance.

2. Features and benefits

- Fully automotive qualified to AEC-Q101:
 - 175 °C rating suitable for thermally demanding environments
- Trench 9 Superjunction technology:
 - Reduced cell pitch enables enhanced power density and efficiency with lower R_{DSon} in same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS
 - Tight V_{GS(th)} limits enable easy paralleling of MOSFETs
- LFPAK Gull Wing leads:
 - High Board Level Reliability absorbing mechanical stress during thermal cycling, unlike traditional QFN packages
 - Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - Easy solder wetting for good mechanical solder joint
- LFPAK copper clip technology:
 - Improved reliability, with reduced R_{th} and R_{DSon}
 - Increases maximum current capability and improved current spreading

3. Applications

- 12 V automotive systems
- Motors, lamps and solenoid control
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

4. Quick reference data

Table 1. Quick reference data

			1			
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	40	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C	-	-	120	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	190	W
Static charact	eristics					
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 10	1.5	2.13	2.5	mΩ

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Dynamic ch	aracteristics	· · · · · ·		•			
Q _{GD}	gate-drain charge	$I_D = 25 \text{ A}; V_{DS} = 32 \text{ V}; V_{GS} = 10 \text{ V}; T_j = 25 \text{ °C}; Fig. 12; Fig. 13$		-	8.9	22	nC
Source-drai	n diode	· · · · ·		•			
Qr	recovered charge	I_{S} = 25 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V;		-	22.7	-	nC
S	softness factor	V _{DS} = 20 V; T _j = 25 °C		-	0.79	-	

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	mb	
2	S	source		D
3	S	source	a	
4	G	gate		G_(E)
mb	D	mounting base; connected to drain	LFPAK56; Power- SO8 (SOT669)	mbb076 S

6. Ordering information

Table 3. Ordering information						
Type number	Package	'ackage				
	Name	Description	Version			
BUK7Y2R5-40H	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package; 4 terminals	<u>SOT669</u>			

7. Marking

Table 4. Marking codes			
Type number	Marking code		
BUK7Y2R5-40H	72H540		

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Tj = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{GS}	gate-source voltage		[1]	-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	190	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C		-	120	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu$ s; $T_{mb} = 25 \ ^{\circ}C$; Fig. 2		-	600	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C

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Symbol	Parameter	Conditions		Min	Max	Unit
Source-drain d	liode		•			
IS	source current	T _{mb} = 25 °C	[2]	-	120	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	600	А
Avalanche rug	gedness		-			
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{array}{l} I_D = 120 \; A; \; V_{sup} \leq 40 \; V; \; R_GS = 50 \; \Omega; \\ V_GS = 10 \; V; \; T_{j(init)} = 25 \; ^\circC; \; unclamped; \\ \hline Fig. 3 \end{array} $	[3] [4]	-	82.1	mJ

[1] Refer to application note AN90001 for further information.

[2] 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

[3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[4] Refer to application note AN10273 for further information.

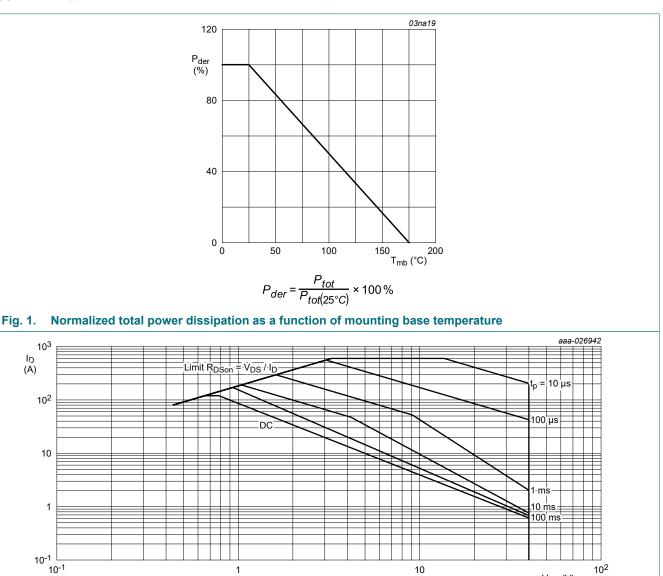
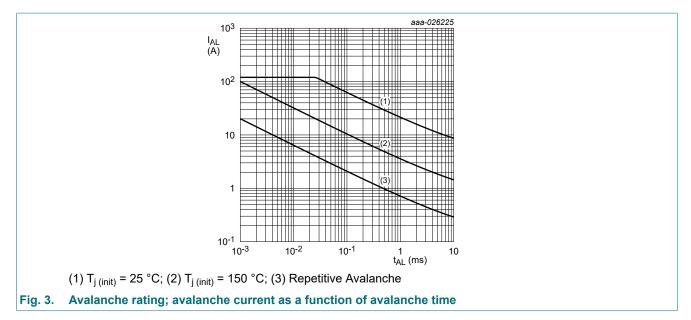


Fig. 2. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

V_{DS} (V)

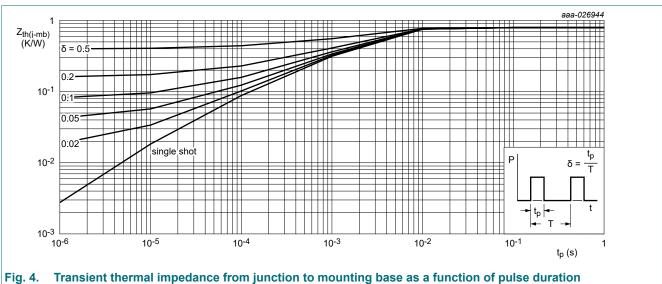
 T_{mb} = 25 °C; I_{DM} is a single pulse

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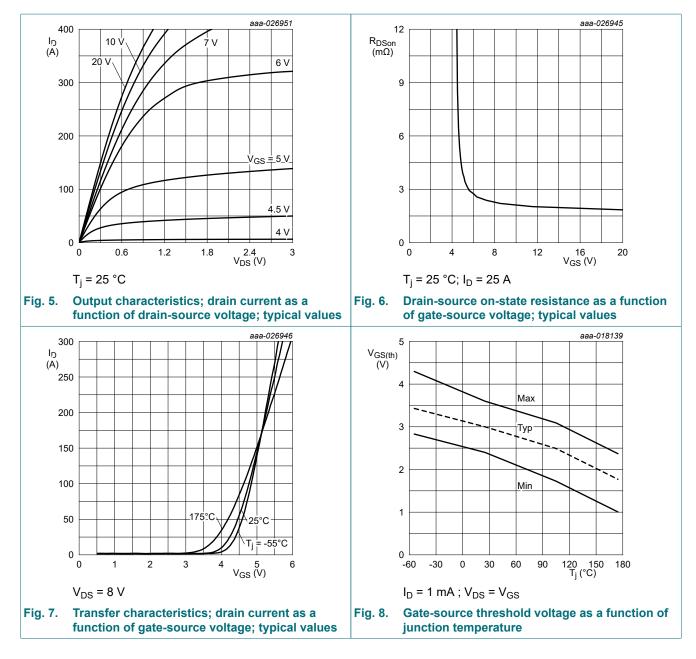
9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 4</u>	-	0.63	0.79	K/W

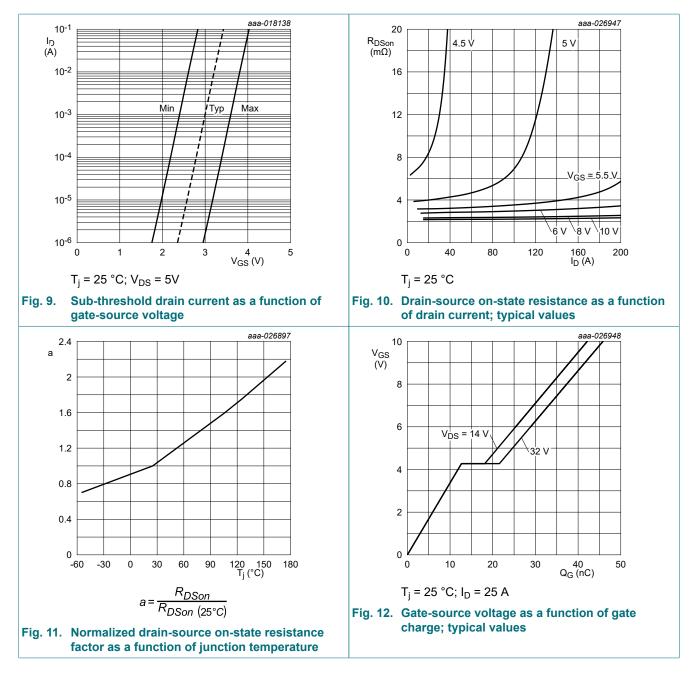


10. Characteristics

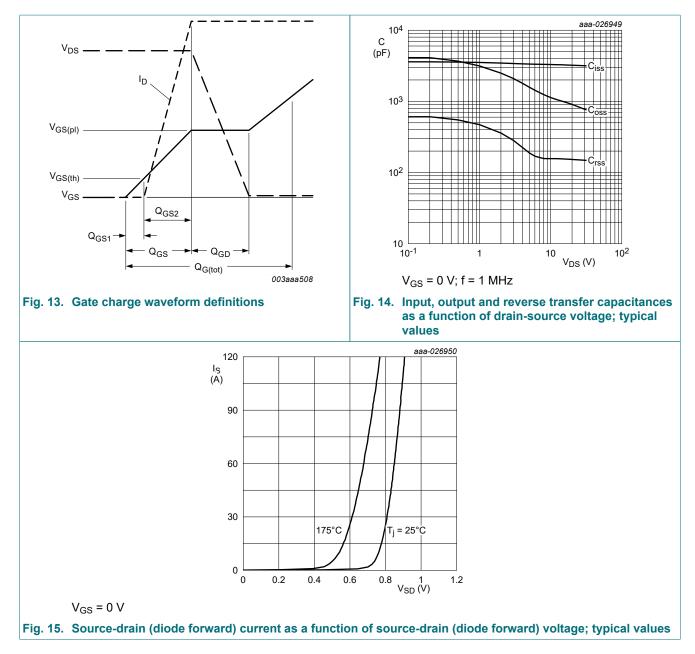
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C	40	43	-	V
()	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C	-	40.7	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _i = -55 °C	36	40	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; <u>Fig. 8;</u> Fig. 9	2.4	3	3.6	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; <u>Fig. 8</u>	-	-	4.3	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; <u>Fig. 8</u>	1	-	-	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.02	1	μA
		V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C	-	1.2	10	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	113	500	μA
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_{j} = 25 \text{ °C}$	-	2	100	nA
		V _{GS} = -16 V; V _{DS} = 0 V; T _i = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 10	1.5	2.13	2.5	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; Fig. 11	2.12	2.82	3.98	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; <u>Fig. 11</u>	2.34	3.18	4.38	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 11</u>	2.94	4.07	5.45	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.3	0.74	1.85	Ω
Dynamic cl	haracteristics					
Q _{G(tot)}	total gate charge	I _D = 25 A; V _{DS} = 32 V; V _{GS} = 10 V;	-	45.8	79	nC
Q _{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 12</u> ; <u>Fig. 13</u>	-	12.7	19	nC
Q _{GD}	gate-drain charge		-	8.9	22	nC
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz;	-	3193	4790	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 14</u>	-	831	1163	pF
C _{rss}	reverse transfer capacitance		-	150	330	pF
t _{d(on)}	turn-on delay time	V_{DS} = 30 V; R _L = 1.2 Ω; V _{GS} = 10 V;	-	12.3	-	ns
t _r	rise time	R _{G(ext)} = 5 Ω; T _j = 25 °C	-	10.3	-	ns
t _{d(off)}	turn-off delay time		-	27.5	-	ns
t _f	fall time	1	-	13	-	ns
Source-dra	in diode		I			
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _i = 25 °C; <u>Fig. 15</u>	-	0.8	1.2	V
t _{rr}	reverse recovery time	$I_{\rm S} = 25 \text{ A}; dI_{\rm S}/dt = -100 \text{ A}/\mu \text{s}; V_{\rm GS} = 0 \text{ V};$	-	29.3	-	ns
Q _r	recovered charge	$V_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 \text{ °C}$	-	22.7	-	nC
S	softness factor		-	0.79	-	
		I _S = 25 A; dI _S /dt = -500 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _i = 25 °C	-	0.65	-	



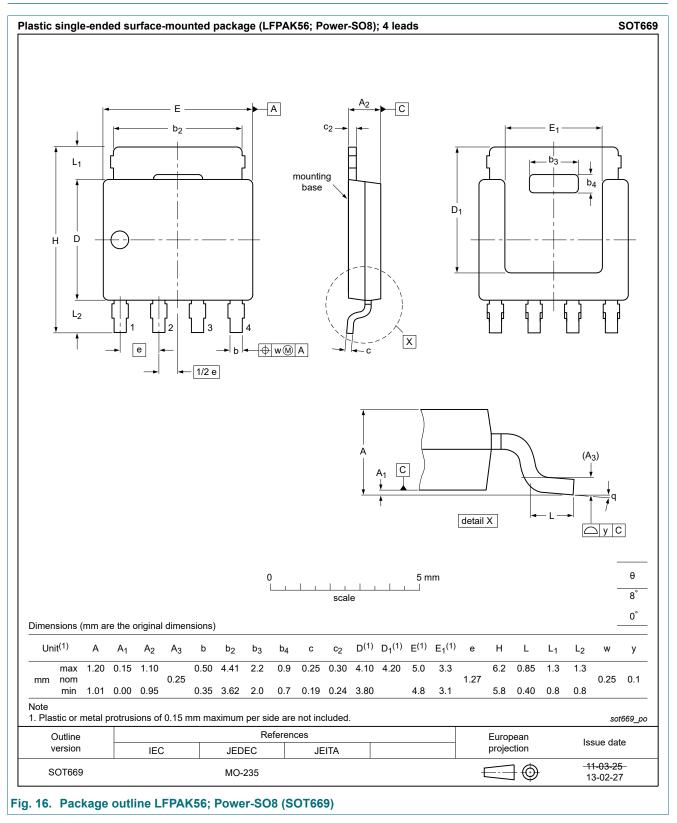
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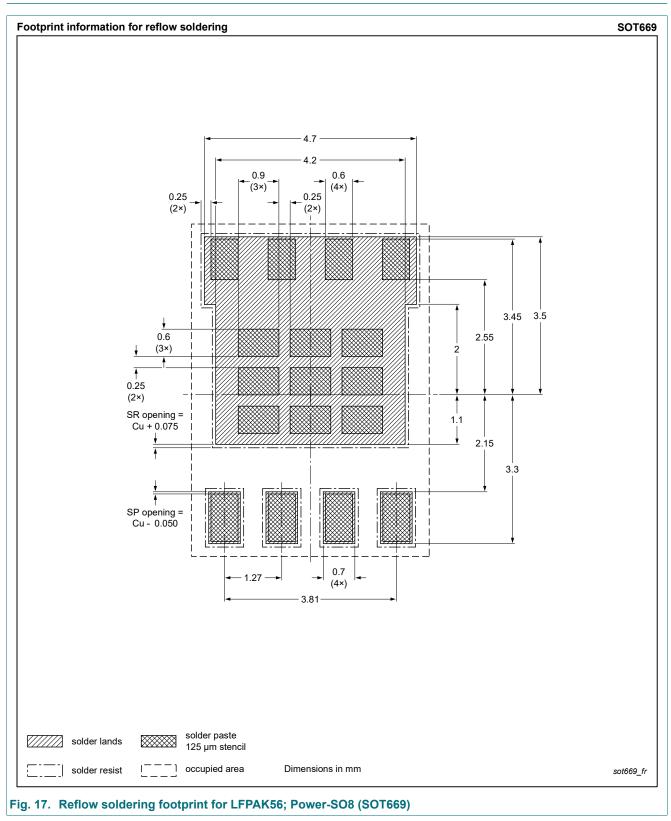
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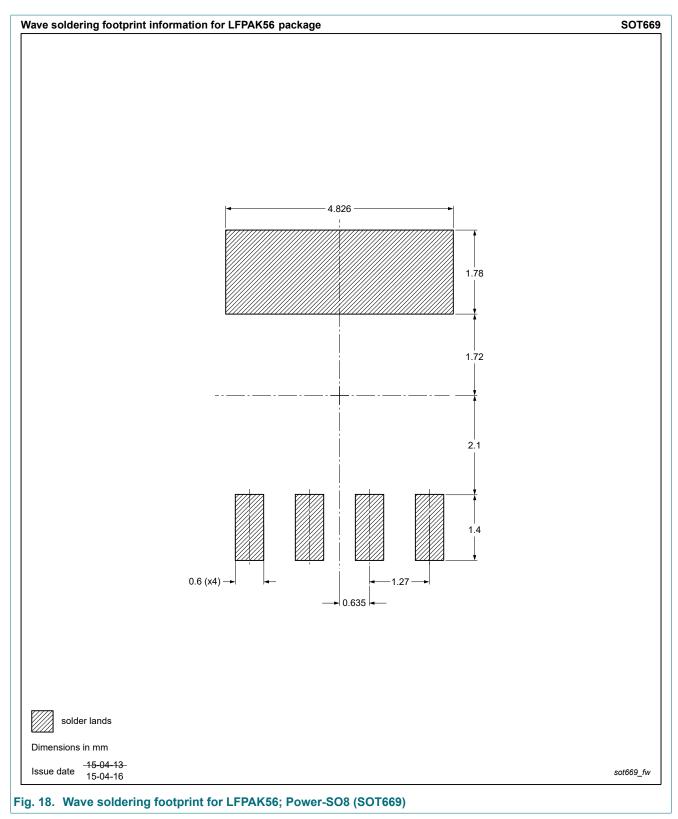
11. Package outline



12. Soldering



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13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Product data sheet

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